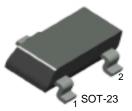


SEMICONDUCTOR TM

# **KST2222A**

# **General Purpose Transistor**



1. Base 2. Emitter 3. Collector

# **NPN Epitaxial Silicon Transistor**

# Absolute Maximum Ratings ${\rm T_a=25^{\circ}C}$ unless otherwise noted

Symbol	Parameter	Value	
V <sub>CBO</sub>	Collector-Base Voltage	75	V
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	6	V
c	Collector Current	600	mA
Pc	Collector Dissipation	350	mW
T <sub>STG</sub>	Storage Temperature	150	°C

Refer to KST2222 for graphs

## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

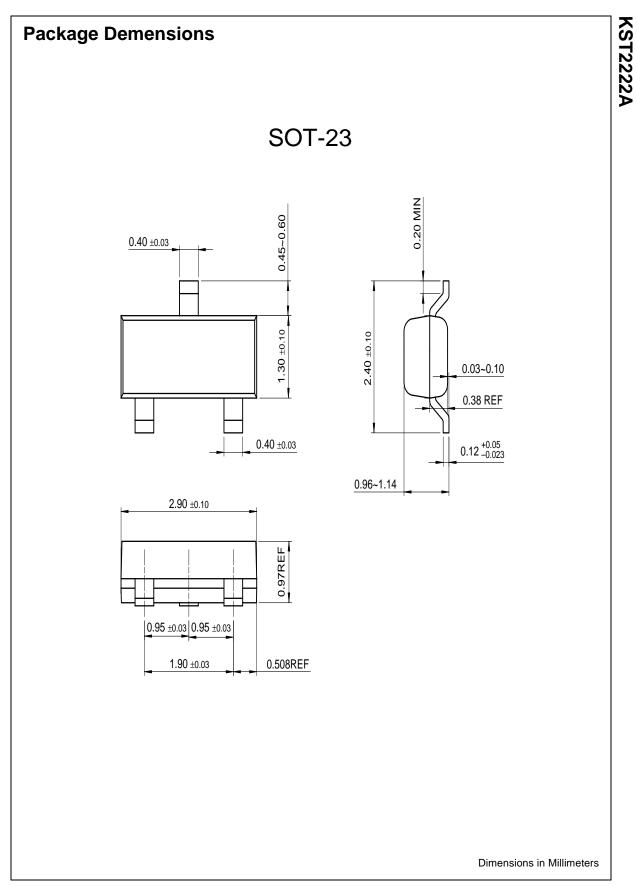
Symbol	Parameter	Test Condition	Min.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> =10μA, I <sub>E</sub> =0	75		V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0	40		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> =10μA, I <sub>C</sub> =0	6		V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> =60V, I <sub>E</sub> =0		0.01	μA
h <sub>FE</sub>	* DC Current Gain	$V_{CE}=10V, I_{C}=0.1mA \\ V_{CE}=10V, I_{C}=1mA \\ V_{CE}=10V, I_{C}=10mA \\ V_{CE}=10V, I_{C}=150mA \\ V_{CE}=10V, I_{C}=500mA \\ \label{eq:central_constraint}$	35 50 75 100 40	300	
V <sub>CE</sub> (sat)	* Collector-Emitter Saturation Voltage	I <sub>C</sub> =150mA, I <sub>B</sub> =15mA I <sub>C</sub> =500mA, I <sub>B</sub> =50mA		0.3 1.0	V V
V <sub>BE</sub> (sat)	* Base-Emitter Saturation Voltage	I <sub>C</sub> =150mA, I <sub>B</sub> =15mA I <sub>C</sub> =500mA, I <sub>B</sub> =50mA	0.6	1.2 2.0	V V
f <sub>T</sub>	Current Gain Bandwidth Product	I <sub>C</sub> =20mA, V <sub>CE</sub> =20V, f=100MHz	300		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz		8	pF
NF	Noise Figure	I <sub>C</sub> =100μA, V <sub>CE</sub> =10V R <sub>S</sub> =1KΩ, f=1MHz		4	dB
t <sub>ON</sub>	Turn On Time	V <sub>CC</sub> =30V, I <sub>C</sub> =150mA V <sub>BE</sub> =0.5V, I <sub>B1</sub> =15mA		35	ns
t <sub>OFF</sub>	Turn Off Time	V <sub>CC</sub> =30V, I <sub>C</sub> =150mA I <sub>B1</sub> =I <sub>B2</sub> =15mA		285	ns

\* Pulse Test: PW≤300µs, Duty Cycle≤2%



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